COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE  BOARD #: PMP9755  REV: A  SUN REV: Not In VersionControl
IGNORE ->  Top Overlay

PLOT NAME = Top Assembly Drawing  GENERATED : 2014/10/18 21:58:01  TEXAS INSTRUMENTS
COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

<table>
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<th>PCB VIEWED FROM BOTTOM SIDE</th>
<th>BOARD #: PMP9755</th>
<th>REV: A</th>
<th>SUN REV: Not In VersionControl</th>
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<tbody>
<tr>
<td></td>
<td>Ignore -&gt;</td>
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<tr>
<td>PLOT NAME = Bottom Assembly Drawing</td>
<td>GENERATED : 2014/10/18 21:58:02</td>
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<td>TEXAS INSTRUMENTS</td>
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